MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

AHPM15–CDI AUTOMOTIVE MODULE
CASE MODHN
ISSUE B

DATE 20 DEC 2022

NOTES:
1. DIMENSIONING AND TOLERANCING PER,
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS D & E DO NOT INCLUDE MOLD
   PROTRUSIONS
4. DIMENSIONS b, b1, b2 DO NOT INCLUDE
   DAMBAR REMAIN.
5. MARKING AREA.
6. #1, 2 LEAD FinISH; NO PLATING
7. #3–#15 LEAD FinISH; Sn PLATING

DOCUMENT NUMBER: 98AON31392H
DESCRIPTION: AHPM15–CDI AUTOMOTIVE MODULE
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GENERIC MARKING DIAGRAM*

ZZZ = Assembly Lot Code
AT = Assembly & Test Location
Y = Year
WW = Work Week
XXXX = Specific Device Code
NNNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “×”, may or may not be present. Some products may not follow the Generic Marking.